

DIM100PHM33-F000

Half Bridge IGBT Module

DS5764-6 March 2021 (LN40739)

FEATURES

- 10µs Short Circuit Withstand
- High Thermal Cycling Capability
- Soft Punch Through Silicon
- Isolated AISiC Base with AIN Substrates
- Lead Free Construction

APPLICATIONS

- High Reliability Inverters
- Motor Controllers
- Traction Auxiliaries

The Powerline range of high power modules includes half bridge, chopper, dual, single and bi-directional switch configurations covering voltages from 1200V to 6500V and currents up to 2400A.

The DIM100PHM33-F000 is a half bridge 3300V soft punch through, n-channel enhancement mode, insulated gate bipolar transistor (IGBT) module. The IGBT has a wide reverse bias safe operating area (RBSOA). This device is optimised for traction drives and other applications requiring high thermal cycling capability.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

DIM100PHM33-F000

Note: When ordering, please use the complete part number

KEY PARAMETERS

VCES		3300V
V _{CE(sat)}	* (typ)	2.8V
lc	(max)	100A
IC(PK)	(max)	200A

* Measured at the auxiliary terminals

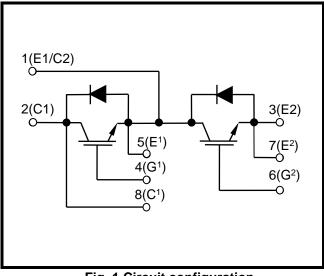
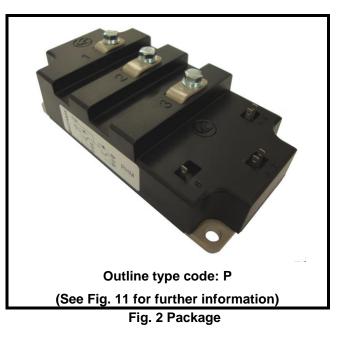


Fig. 1 Circuit configuration



Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures

ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
VCES	Collector-emitter voltage	V _{GE} = 0V	3300	V
V _{GES}	Gate-emitter voltage		±20	V
lc	Continuous collector current	$T_{case} = 90^{\circ}C$	100	А
IC(PK)	Peak collector current	1ms, T _{case} = 115°C	200	А
P _{max}	Max. transistor power dissipation	$T_{case} = 25^{\circ}C, T_j = 150^{\circ}C$	1.3	kW
l²t	Diode I ² t value	$V_R = 0, t_p = 10ms, T_j = 125^{\circ}C$	5	kA ² s
Visol	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	6000	V
QPD	Partial discharge – per module	IEC1287, $V_1 = 3500V$, $V_2 = 2600V$, 50Hz RMS	10	рС

THERMAL AND MECHANICAL RATINGS

Internal insulation material:	AIN
Baseplate material:	AISiC
Creepage distance:	33mm
Clearance:	20mm
CTI (Comparative Tracking Index):	>600

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
R _{th(j-c)}	Thermal resistance – transistor	Continuous dissipation - junction to case	-	-	96	°C/kW
Rth(j-c)	Thermal resistance – Diode	Continuous dissipation - junction to case	-	-	192	°C/kW
Rth(c-h)	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	-	16	°C/kW
Tj	Junction temperature	Transistor	-	-	150	°C
		Diode	-	-	125	°C
T _{stg}	Storage temperature range -		-40	-	125	°C
		Mounting – M6	-	-	5	Nm
	Screw torque	Electrical connections – M5	-	-	4	Nm

ELECTRICAL CHARACTERISTICS

T_{case} = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
	0	$V_{GE} = 0V, V_{CE} = V_{CES}$			1	mA
I _{CES}	Collector cut-off current	$V_{GE} = 0V$, $V_{CE} = V_{CES}$, $T_{case} = 125^{\circ}C$			8	mA
IGES	Gate leakage current	$V_{GE} = \pm 20V, V_{CE} = 0V$		400		nA
V _{GE(TH)}	Gate threshold voltage	Ic = 10mA, V _{GE} = V _{CE}	5.5	6.5	7.0	V
V(+	Collector-emitter	V _{GE} = 15V, I _C = 100A		2.8		V
V _{CE(sat)} †	saturation voltage	$V_{GE} = 15V, I_C = 100A, T_j = 125^{\circ}C$		3.6		V
lF	Diode forward current	DC		100		А
Ifm	Diode maximum forward current	t _p = 1ms		200		Α
	Diada famuard valtage	I _F = 100A		2.9		V
V _F †	Diode forward voltage	I _F = 100A, T _j = 125°C		3.0		V
Cies	Input capacitance	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$		18		nF
Qg	Gate charge	±15V		2.5		μC
Cres	Reverse transfer capacitance	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz		0.28		nF
L _M	Module inductance			40		nH
RINT	Internal transistor resistance			540		μΩ
SC _{Data}	Short circuit current, I _{SC}	$\begin{split} T_{j} &= 125^{\circ}C, \ V_{CC} = 2500V \\ t_{p} &\leq 10 \mu s, \ V_{GE} \leq 15V \\ V_{CE \ (max)} &= V_{CES} - L^{*} \ x \ dI/dt \\ IEC \ 60747-9 \end{split}$		470		A

Note:

 $^{\dagger}\,$ Measured at the the auxiliary terminals $^{\star}\,$ L is the circuit inductance + L_{M}

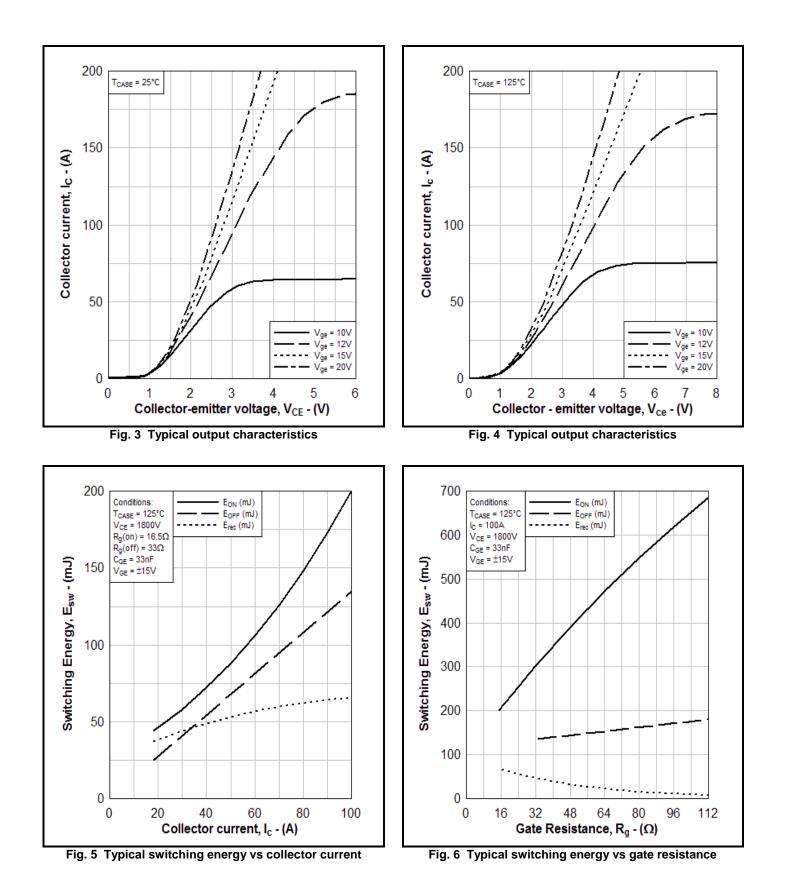
ELECTRICAL CHARACTERISTICS

T_{case} = 25°C unless stated otherwise

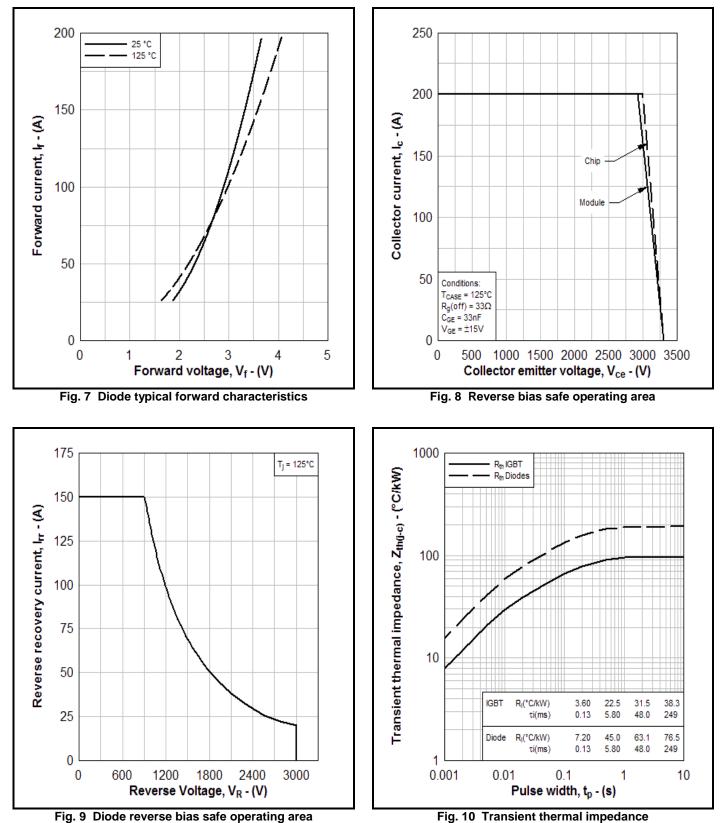
Symbol	Parameter	Test Co	nditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time				1950		ns
t _f	Fall time	I _C = 100A	$\begin{array}{l} R_{G(ON)}=33\Omega \\ R_{G(OFF)}=33\Omega \end{array}$		170		ns
Eoff	Turn-off energy loss	$V_{GE} = \pm 15V$			110		mJ
t _{d(on)}	Turn-on delay time	V _{CE} = 1800V C _{ge} = 33nF			1180		ns
tr	Rise time	Ls ~ 100nH			225		ns
Eon	Turn-on energy loss		$\begin{array}{l} R_{G(ON)} = 16.5\Omega, \\ R_{G(OFF)} = 33\Omega \end{array}$		150		mJ
Q _{rr}	Diode reverse recovery charge	I _F = 100A			40		μC
Irr	Diode reverse recovery current		1800V		75		А
Erec	Diode reverse recovery energy	dI _F /dt = 800A/µs			40		mJ

T_{case} = 125°C unless stated otherwise

Symbol	Parameter	Test Co	nditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time				2200		ns
t _f	Fall time	Ic = 100A	$\begin{array}{l} R_{G(ON)}=33\Omega \\ R_{G(OFF)}=33\Omega \end{array}$		190		ns
EOFF	Turn-off energy loss	$V_{GE} = \pm 15V$			135		mJ
t _{d(on)}	Turn-on delay time	V _{CE} = 1800V C _{ge} = 33nF			1150		ns
tr	Rise time	Ls ~ 100nH			280		ns
Eon	Turn-on energy loss		$\begin{array}{l} R_{G(ON)} = 16.5\Omega, \\ R_{G(OFF)} = 33\Omega \end{array}$		200		mJ
Qrr	Diode reverse recovery charge	IF = 100A			65		μC
Irr	Diode reverse recovery current		1800V		85		А
E _{rec}	Diode reverse recovery energy	dl _F /dt =	800A/µs		65		mJ

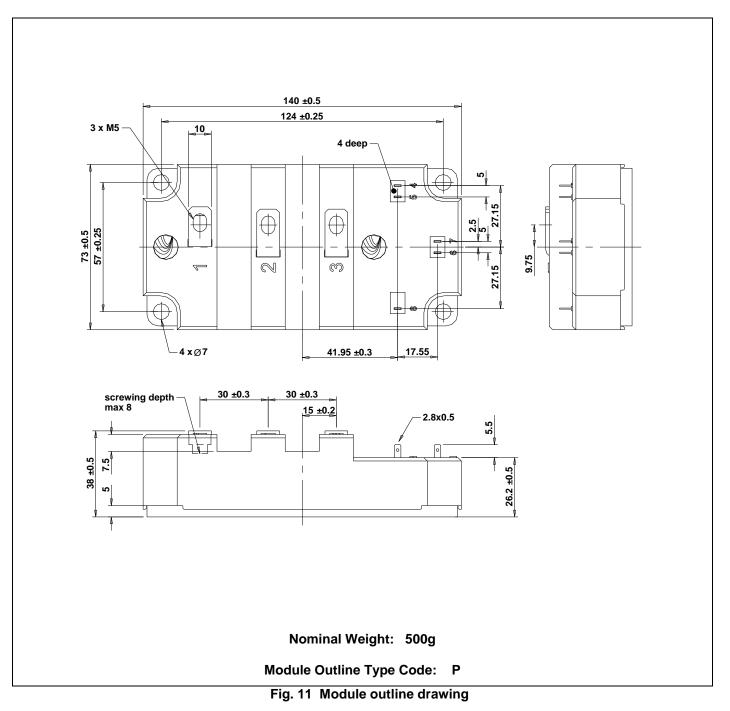


Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures



PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise. **DO NOT SCALE.**



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